

3474AN/GADB-AMNA/X/MS

Features

- High luminous intensity output
- Oval Shape
- Well defined spatial radiation
- Wide viewing angle $(2 \theta_{1/2}) : 110^{\circ} / 50^{\circ}$
- The product itself will remain within RoHS compliant version
- UV resistant epoxy



Descriptions

- This precision optical performance oval LED is specifically designed for passenger information signs
- This lamp has matched radiation patterns with red and blue mixing color applications

Applications

- Color Graphic Signs
- Message boards
- Variable message signs (VMS)
- Commercial outdoor advertising

Device Selection Guide

LED Part No.	Chip Material	Emitted Color	Lens Color	Stopper
3474AN/GADB-AMNA/MS	LCN	D '11'	C D:cc 1	No
3474AN/GADB-AMNA/P/MS	InGaN	Brilliant Green	Green Diffused	Yes

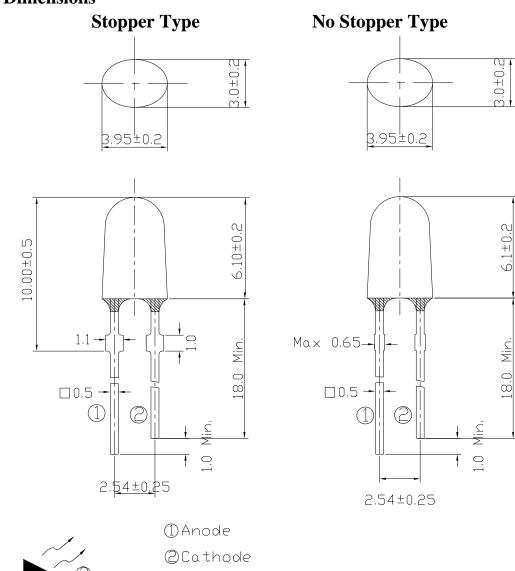
Everlight Electronics Co., Ltd. http:\\www.everlight.com Rev 1 Page: 1 of 9

Device Number: DLE-0000640 Prepared date:12-23-2008 Prepared by: Flourix Chen



3474AN/GADB-AMNA/X/MS

Package Dimensions



Notes:

- All dimensions are in millimeters, tolerance is 0.25mm except being specified.
- Protruded resin under flange is 1.5mm Max LED.
- Bare copper alloy is exposed at tie-bar portion after cutting.

Everlight Electronics Co., Ltd. http:\\www.everlight.com Rev 1 Page: 2 of 9

Device Number: DLE-0000640 Prepared date:12-23-2008 Prepared by: Flourix Chen



3474AN/GADB-AMNA/X/MS

Absolute Maximum Rating $(T_a=25^{\circ}C)$

Parameter	Symbol	Absolute Maximum Rating	Unit
Forward Current	$ m I_F$	30	mA
Pulse Forward Current (Duty1/10@ 1KHz)	I_{FP}	100	mA
Operating Temperature	$T_{ m opr}$	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	$T_{ m stg}$	-40 ~ +100	$^{\circ}\!\mathbb{C}$
Soldering Temperature	T_{sol}	260	$^{\circ}$
Power Dissipation	P_d	100	mW
Reverse Voltage	VR	5	V
Electrostatic Discharge	ESD	1K	V

Notes: Soldering time ≤ 5 seconds.

Electro-Optical Characteristics ($T_a=25^{\circ}C$)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I_V	2880		4970	mcd	
Viewing Angle	$2 heta_{ ext{1/2}}$		X:110 Y:50		deg	
Peak Wavelength	λp		522			T 20 1
Dominant Wavelength	λ_d	525		535	nm	$I_F=20\text{mA}$
Spectrum Half width	Δλ		35			
Forward Voltage	V_F	2.8		3.6	V	
Reverse Current	I_R			50	μ A	$V_R=5V$

Rank Combination (I_F=20mA)

Rank	M1	M2	N1
Luminous Intensity	2880~3450	3450~4140	4140~4970

^{*}Measurement Uncertainty of Luminous Intensity: ±10%

Unit:mcd

Rank	1	2
Dominant Wavelength	525~530	530~535

^{*}Measurement Uncertainty of Dominant Wavelength ±1.0nm

Unit:nm

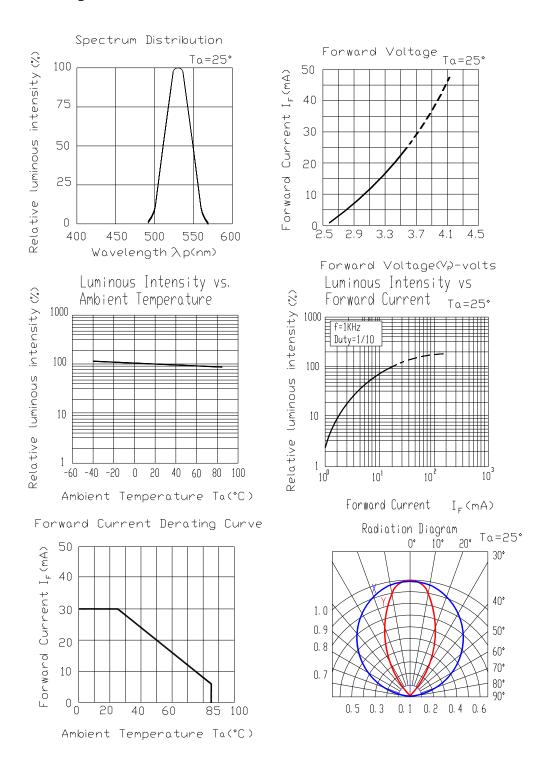
Everlight Electronics Co., Ltd. http:\\www.everlight.com Rev 1 Page: 3 of 9

Device Number: DLE-0000640 Prepared date:12-23-2008 Prepared by: Flourix Chen



3474AN/GADB-AMNA/X/MS

Typical Electro-Optical Characteristics Curves



Everlight Electronics Co., Ltd. http:\\www.everlight.com Rev 1 Page: 4 of 9

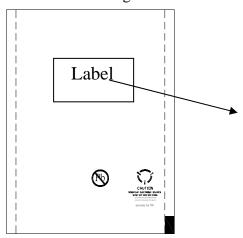
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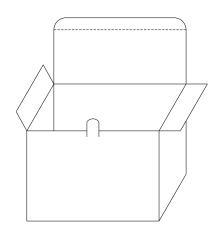
3474AN/GADB-AMNA/X/MS

Packing Specification

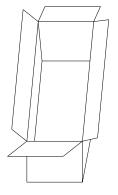
■ Anti-electrostatic bag



■ Inner Carton



■ Outside Carton





■ Label Form Specification

CPN: Customer's Production Number

P/N : Production Number QTY: Packing Quantity

CAT: Ranks of Luminous Intensity and Forward Voltage

HUE: Rank of Dominant Wavelength

REF: Reference

LOT No: Lot Number

MADE IN TAIWAN: Production Place

■ Packing Quantity

1. 1000 PCS/1 Bag, 5 Bags/1 Inner Carton

2. 10 Inner Cartons/1 Outside Carton

Everlight Electronics Co., Ltd. http:\\www.everlight.com Rev 1 Page: 5 of 9

Device Number: DLE-0000640 Prepared date:12-23-2008 Prepared by: Flourix Chen



3474AN/GADB-AMNA/X/MS

Notes

1. Lead Forming

- During lead formation, the leads should be bent at a point at least 3mm from the base of the epoxy bulb.
- Lead forming should be done before soldering.
- Avoid stressing the LED package during leads forming. The stress to the base may damage the LED's characteristics or it may break the LEDs.
- Cut the LED leadframes at room temperature. Cutting the leadframes at high temperatures may cause failure of the LEDs.
- When mounting the LEDs onto a PCB, the PCB holes must be aligned exactly with the lead position of the LED. If the LEDs are mounted with stress at the leads, it causes deterioration of the epoxy resin and this will degrade the LEDs.

2. Storage

- The LEDs should be stored at 30°C or less and 70%RH or less after being shipped from Everlight and the storage life limits are 3 months. If the LEDs are stored for 3 months or more, they can be stored for a year in a sealed container with a nitrogen atmosphere and moisture absorbent material.
- Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.

3. Soldering

Careful attention should be paid during soldering. When soldering, leave more then 3mm from solder joint to epoxy bulb, and soldering beyond the base of the tie bar is recommended.

Everlight Electronics Co., Ltd. http:\\www.everlight.com Rev 1 Page: 6 of 9

Device Number: DLE-0000640 Prepared date:12-23-2008 Prepared by: Flourix Chen

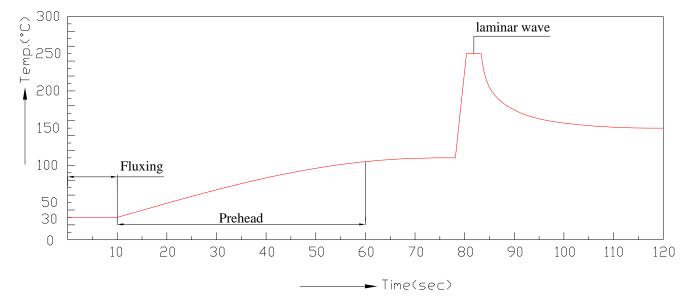


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■ Recommended soldering conditions:

Hand Soldering		DIP Soldering		
T	300°C Max. (30W	Duals and days a	100°C Max. (60 sec	
Temp. at tip of iron	Max.)	Preheat temp.	Max.)	
Soldering time	3 sec Max.	Bath temp. & time	260 Max., 5 sec Max	
Distance	3mm Min.(From	Distance	3mm Min. (From	
	solder joint to		solder joint to epoxy	
	epoxy bulb)		bulb)	

■ Recommended soldering profile



- Avoiding applying any stress to the lead frame while the LEDs are at high temperature particularly when soldering.
- Dip and hand soldering should not be done more than one time
- After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- Although the recommended soldering conditions are specified in the above table, dip or handsoldering at the lowest possible temperature is desirable for the LEDs.

Everlight Electronics Co., Ltd. http:\\www.everlight.com Rev 1 Page: 7 of 9

Device Number: DLE-0000640 Prepared date:12-23-2008 Prepared by: Flourix Chen



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■ Wave soldering parameter must be set and maintain according to recommended temperature and dwell time in the solder wave.

4. Cleaning

- When necessary, cleaning should occur only with isopropyl alcohol at room temperature for a duration of no more than one minute. Dry at room temperature before use.
- Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Ultrasonic cleaning shall be pre-qualified to ensure this will not cause damage to the LED

5. Heat Management

- Heat management of LEDs must be taken into consideration during the design stage of LED application. The current should be de-rated appropriately by referring to the de-rating curve found in each product specification.
- The temperature surrounding the LED in the application should be controlled. Please refer to the data sheet de-rating curve.

6. ESD (Electrostatic Discharge)

- Electrostatic discharge (ESD) or surge current (EOS) can damage LEDs.
- An ESD wrist strap, ESD shoe strap or antistatic gloves must be worn whenever handling LEDs.
- All devices, equipment and machinery must be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing.

7. Other

- Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for

Everlight Electronics Co., Ltd. http://www.everlight.com Rev 1 Page: 8 of 9

Device Number: DLE-0000640 Prepared date:12-23-2008 Prepared by: Flourix Chen



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- any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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Everlight Electronics Co., Ltd. http:\\www.everlight.com Rev 1 Page: 9 of 9

Device Number: DLE-0000640 Prepared date:12-23-2008 Prepared by: Flourix Chen

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